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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the **PATENT APPLICATION** of:

Shinichi Ogimoto

Application No.: 10/786,402

Confirmation No.: 2893

Filed: February 25, 2004

For: METHOD FOR BONDING
SUBSTRATES AND APPARATUS FOR
BONDING SUBSTRATES

Group: 1734

Examiner: Koch, George R.

Our File: SAS2-PT069

Date: April 6, 2005

**PRELIMINARY AMENDMENT AND REPLY PURSUANT
TO 37 C.F.R. §1.111**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This Reply is responsive to the Office Action dated March 9, 2005. Please amend the application without prejudice as follows: